MOSFET – N-Channel, SUPERFET III, FRFET

650 V, 40 A, 82 m Ω

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 70 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 81 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 722 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

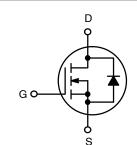
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar



ON Semiconductor®

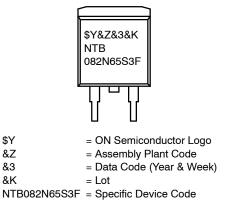
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V _{DSS}	R _{DS(ON)} MAX	I _D MAX		
650 V	82 mΩ @ 10 V	40 A		





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit V		
V _{DSS}	Drain to Source Voltage			650	
V _{GSS}	Gate to Source Voltage	DC	±30	V	
		AC (f > 1 Hz)	±30	V	
I _D	Drain Current	Continuous (T _C = 25°C)	40	А	
		Continuous (T _C = 100°C)	25.5		
I _{DM}	Drain Current	Pulsed (Note 1)	100	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		510	mJ	
I _{AS}	Avalanche Current (Note 2)		4.8	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		3.13	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50		
P _D	Power Dissipation	(T _C = 25°C)	313	W	
		Derate Above 25°C	2.5	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 4.8 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$. 3. $I_{SD} \le 20 \text{ A}$, di/dt $\le 100 \text{ A}/\mu\text{s}$, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}C$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	°CAN
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (1 in ² Pad of 2-oz Copper), Max.	62.5	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity	
NTB082N65S3F	NTB082N65S3F	D ² PAK	Tape and Reel [†]	330 mm	24 mm	800 Units	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650	-	-	V
		V_{GS} = 0 V, I_{D} = 1 mA, T_{J} = 150°C	700	-	-	V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to $25^{\circ}C$	-	0.7	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V	-	-	10	μA
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	124	-	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1.0$ mA	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	70	82	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 20 A	-	24	-	S
DYNAMIC CHA	RACTERISTICS	-				-
C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	-	3410	-	pF
C _{oss}	Output Capacitance		-	70	-	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 \text{ V}$ to 400 V, $V_{GS} = 0 \text{ V}$	-	722	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	$V_{DS} = 0 \text{ V}$ to 400 V, $V_{GS} = 0 \text{ V}$	-	126	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V_{DS} = 400 V, I _D = 20 A, V _{GS} = 10 V (Note 4)	-	81	-	nC
Q _{gs}	Gate to Source Gate Charge		-	24	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	32	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	1.9	-	Ω
SWITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V_{DD} = 400 V, I_D = 20 A, V_{GS} = 10 V, R_g = 3 Ω (Note 4)	-	27	-	ns
t _r	Turn-On Rise Time		-	27	-	ns
t _{d(off)}	Turn-Off Delay Time		-	79	-	ns
t _f	Turn-Off Fall Time		-	5	-	ns
SOURCE-DRAI	N DIODE CHARACTERISTICS	-				-
۱ _S	Maximum Continuous Source to Drain Diode Forward Current			-	40	Α
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current		-	- 1	100	А
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 20 \text{ A}$	-	-	1.3	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 20 A,$	-	108	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	-	410	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

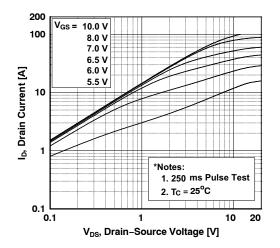


Figure 1. On-Region Characteristics

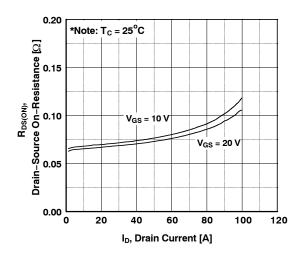


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

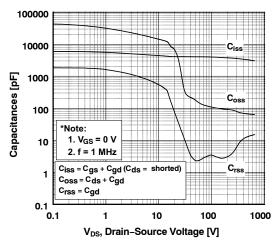


Figure 5. Capacitance Characteristics

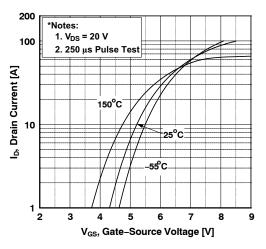


Figure 2. Transfer Characteristics

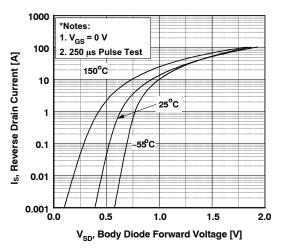


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

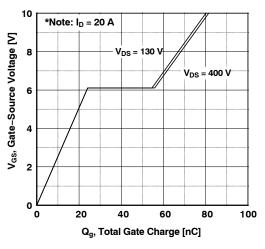
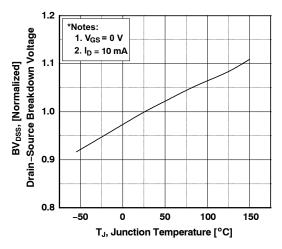


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





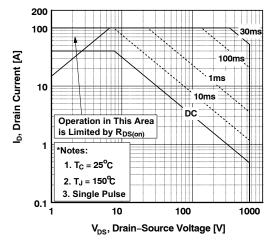


Figure 9. Maximum Safe Operation Area

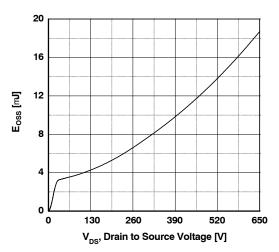


Figure 11. E_{OSS} vs. Drain to Source Voltage

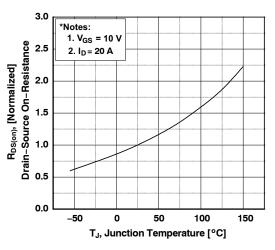


Figure 8. On-Resistance Variant vs. Temperature

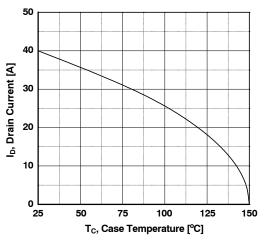


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

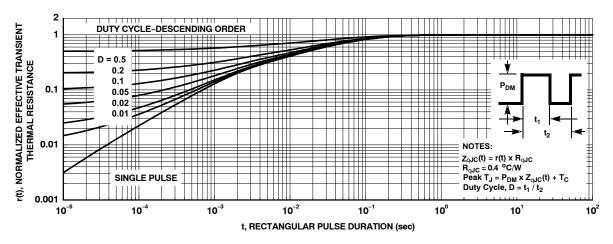
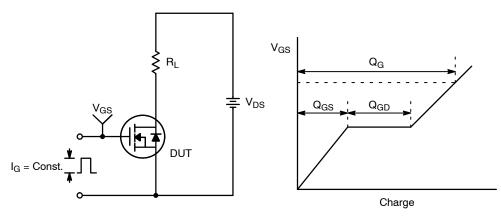


Figure 12. Transient Thermal Response Curve





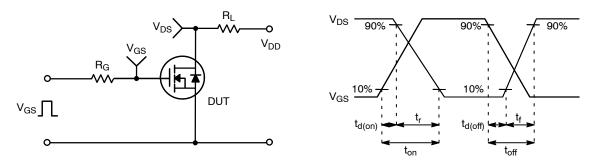
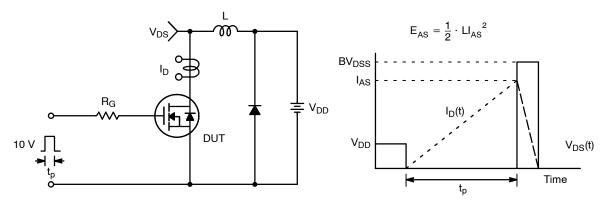


Figure 14. Resistive Switching Test Circuit & Waveforms





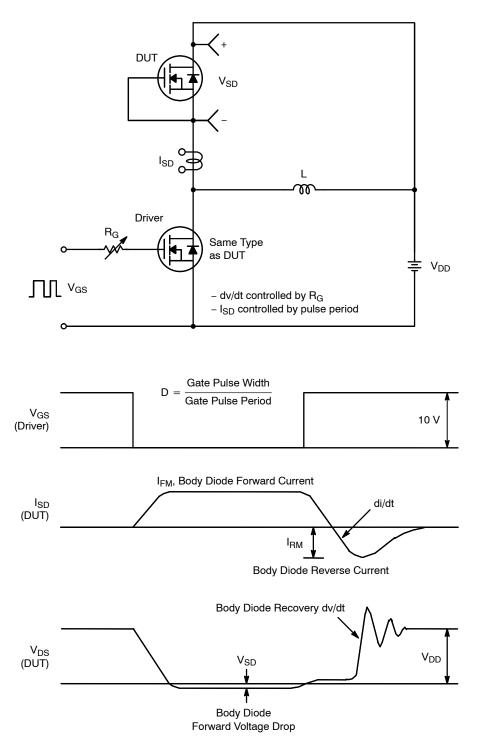
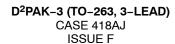


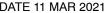
Figure 16. Peak Diode Recovery dt/dt Test Circuit & Waveforms

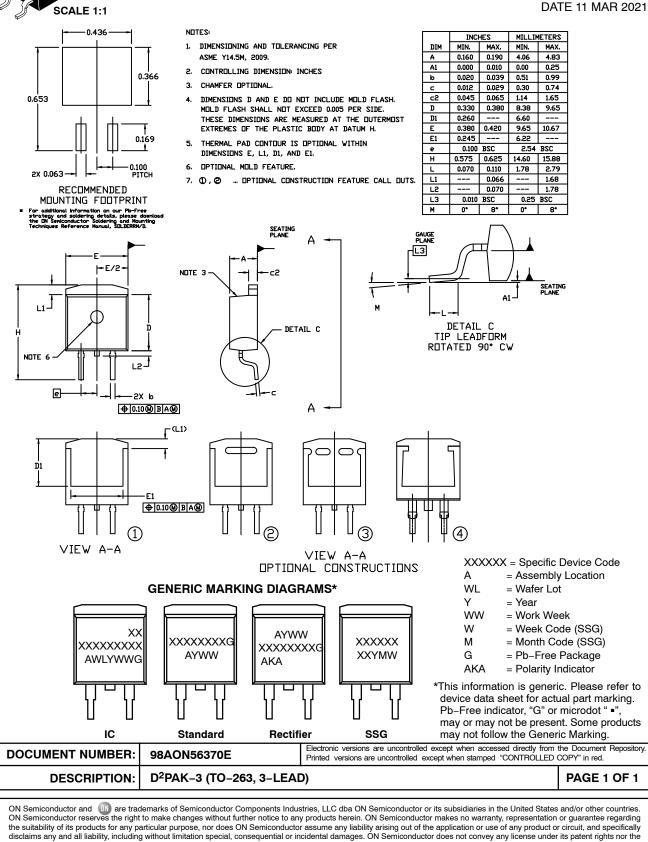
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS









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